

V_{RRM} = 4500 V
 $I_{F(AV)M}$ = 2070 A
 I_{FSM} = $45 \cdot 10^3$ A
 V_{F0} = 1.56 V
 r_F = 0.80 mΩ
 $V_{DC-Link}$ = 2800 V

Fast Recovery Diode

5SDF 20L4521

Preliminary

Doc. No. 5SYA1186-03 Jun. 19

- Industry standard housing
- Cosmic radiation withstand rating
- Optimized low switching losses
- Optimized for IGBT operation
- High RBSOA up to high di/dt

Blocking

Maximum rated values¹⁾

Parameter	Symbol	Conditions	5SDF 20L4521		Unit
Repetitive peak reverse voltage	V_{RRM}	$f = 50$ Hz, $t_p = 10$ ms, $T_{vj} = 140$ °C	4500		V
Permanent DC voltage for 100 FIT failure rate	$V_{DC-link}$	Ambient cosmic radiation at sea level in open air.	2800		V
		100% Duty	3200		
<i>Characteristic values</i>					

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Reverse leakage current	I_{RRM}	$V_{RRM}, T_{vj} = 140$ °C			150	mA

Mechanical data

Maximum rated values¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	F_M		36	40	70	kN
Acceleration	a	Device unclamped			50	m/s ²
Acceleration	a	Device clamped			200	m/s ²

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Weight	m				1.45	kg
Housing thickness	H	$F_M = 40$ kN, $T_a = 25$ °C	25.85		26.25	mm
Surface creepage distance	D _s		33			mm
Air strike distance	D _a		14			mm

1) Maximum rated values indicate limits beyond which damage to the device may occur

On-state*Maximum rated values¹⁾*

Parameter	Symbol	Conditions	min	typ	max	Unit
Average on-state current	I _{F(AV)M}	Half sine wave, T _c = 70 °C			2070	A
RMS on-state current	I _{F(RMS)}				3250	A
Peak non-repetitive surge current	I _{FSM}	t _p = 10 ms, T _{vj} = 140 °C, sine half wave,			45·10 ³	A
Limiting load integral	I ² t	V _R = 0 V, after surge			10.1·10 ⁶	A ² s

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	V _F	I _F = 3300 A, T _{vj} = 140 °C		3.69	4.2	V
Threshold voltage	V _{F0}				1.56	V
Slope resistance	r _F	I _F = 500...3500 A, T _{vj} = 140 °C			0.80	mΩ

Turn-on*Characteristic values*

Parameter	Symbol	Conditions	min	typ	max	Unit
Peak forward recovery voltage	V _{FRM}	dI _F /dt = 3000 A/μs, I _{FM} = 5500 A, T _{vj} = 140 °C		200		V

Turn-off*Maximum rated values¹⁾*

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. decay rate of on-state current	di/dt _{crit}				TBD	A/μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Reverse recovery charge	Q _{rr}	I _F = 3000 A, V _{DC-Link} = 2800 V,		5200	6400	μAs
Reverse recovery current	I _{RM}	di/dt = 5000 A/μs, L _σ = 200 nH, IGBT = 5SNA 2000K450300,		3500	4300	A
Turn-off energy	E _{rr}	T _{vj} = 140 °C, V _{GE} = ±15 V		10.0	12.4	J

Thermal

Maximum rated values¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Operating junction temperature range	T _{vj}				140	°C
Storage temperature range	T _{stg}		-40		125	°C

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	R _{th(j-c)}	Double-side cooled F _m = 36... 70 kN			6	K/kW
	R _{th(j-c)A}	Anode-side cooled F _m = 36... 70 kN			11.2	K/kW
	R _{th(j-c)C}	Cathode-side cooled F _m = 36... 70 kN			12.9	K/kW
Thermal resistance case to heatsink	R _{th(c-h)}	Double-side cooled F _m = 36... 70 kN			3	K/kW
	R _{th(c-h)}	Single-side cooled F _m = 36... 70 kN			6	K/kW

Analytical function for transient thermal impedance:

$$Z_{\text{th}(j-c)}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

i	1	2	3	4
R _i (K/kW)	3.708	1.426	0.686	0.176
τ _i (s)	0.5336	0.0670	0.0074	0.0011

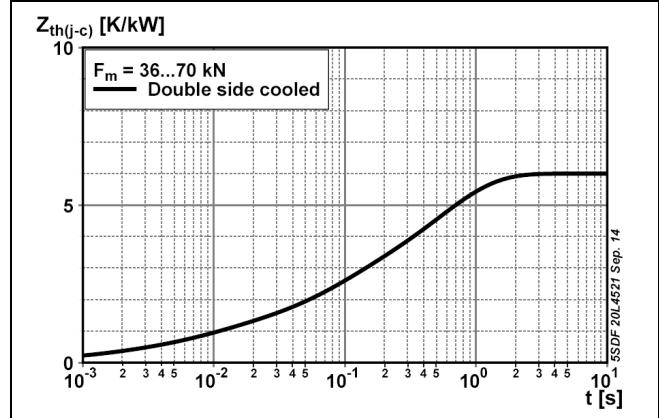


Fig. 1 Transient thermal impedance (junction-to-case) vs. time

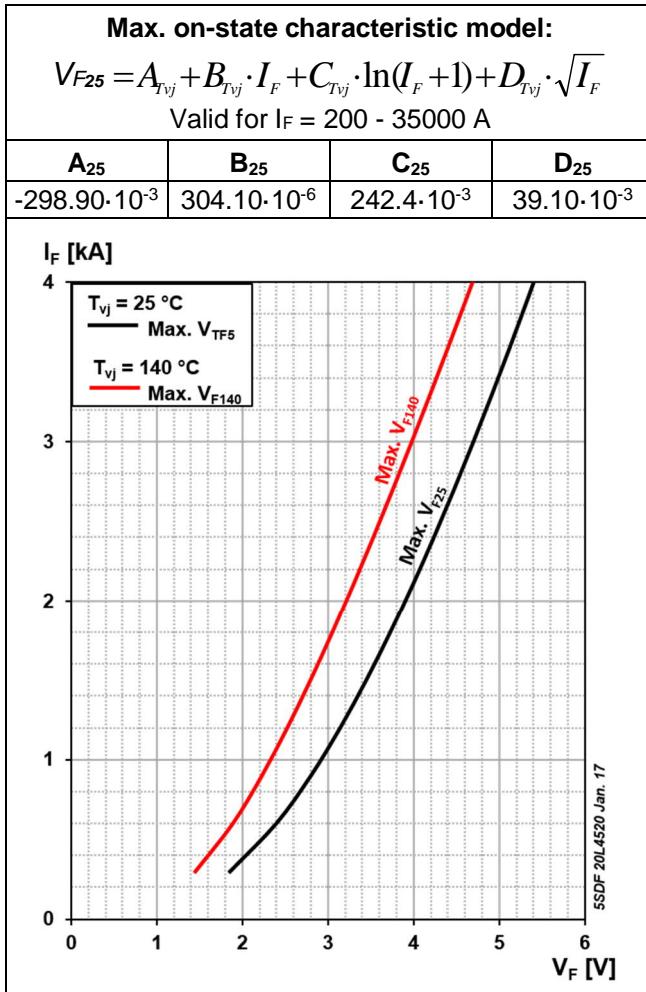


Fig. 2 On-state voltage characteristics

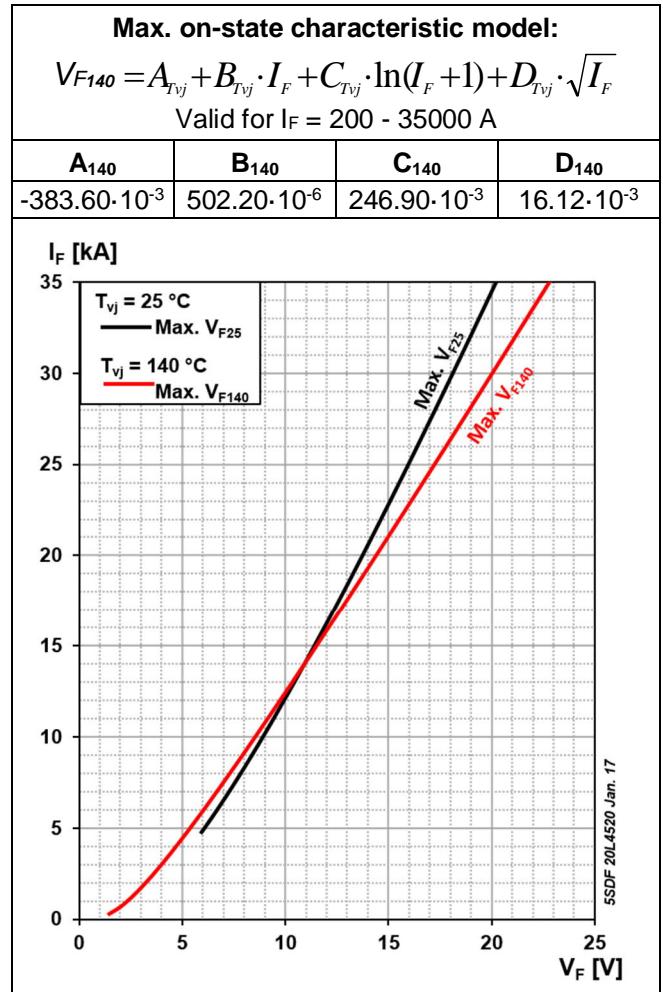


Fig. 3 On-state voltage characteristics

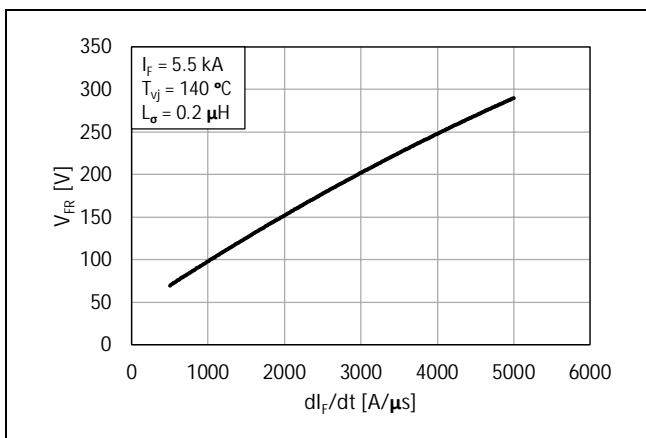


Fig. 4 Peak forward recovery voltage

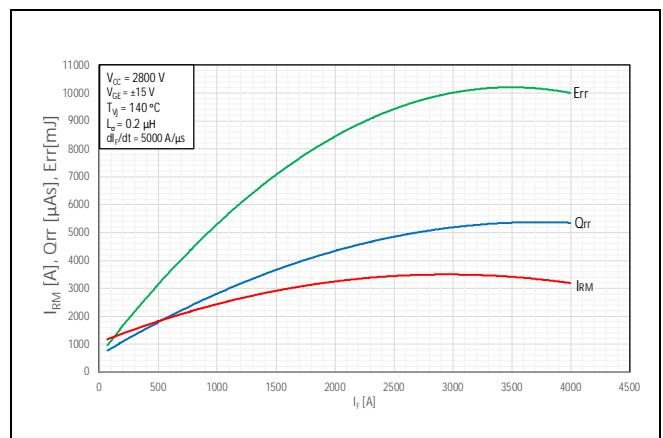


Fig. 5 Reverse recovery characteristics (typical values)

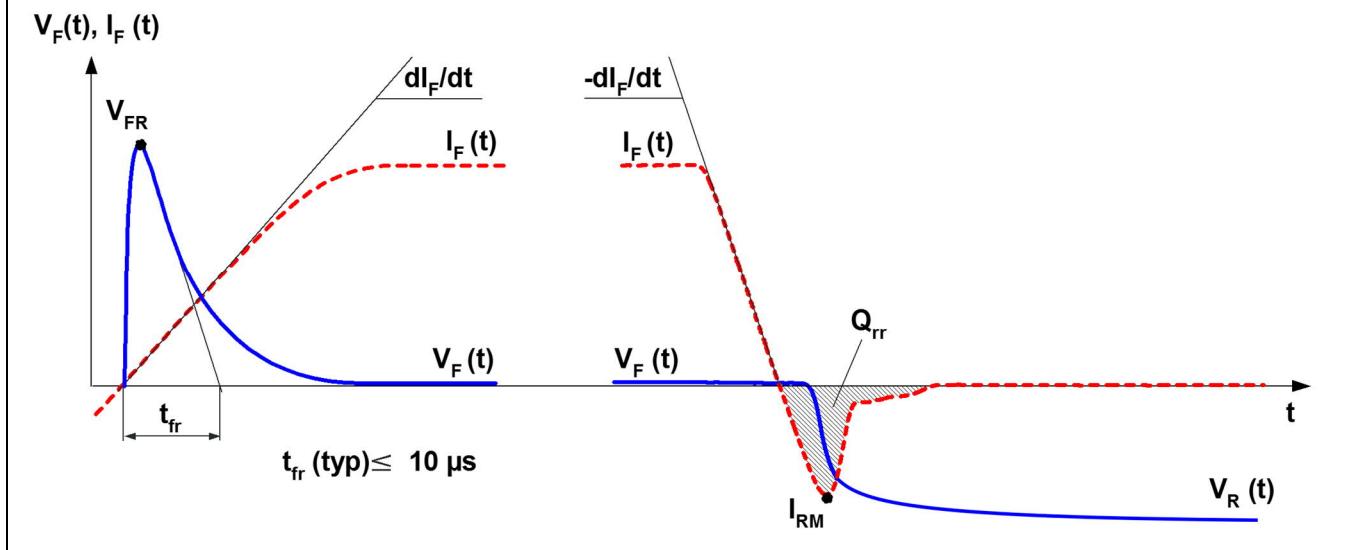


Fig. 6 General current and voltage waveforms

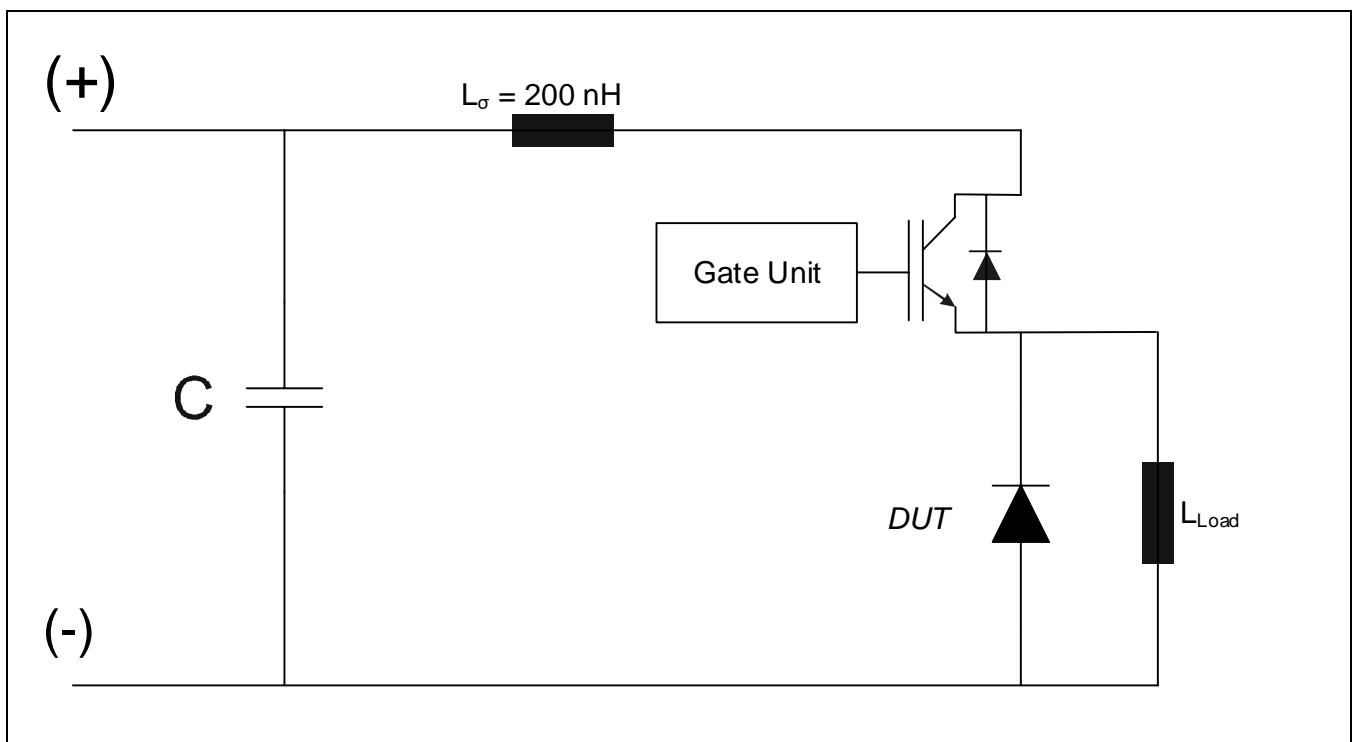


Fig. 7 Reverse recovery test circuit. Fast Recovery Diode (DUT) in IGBT Application.

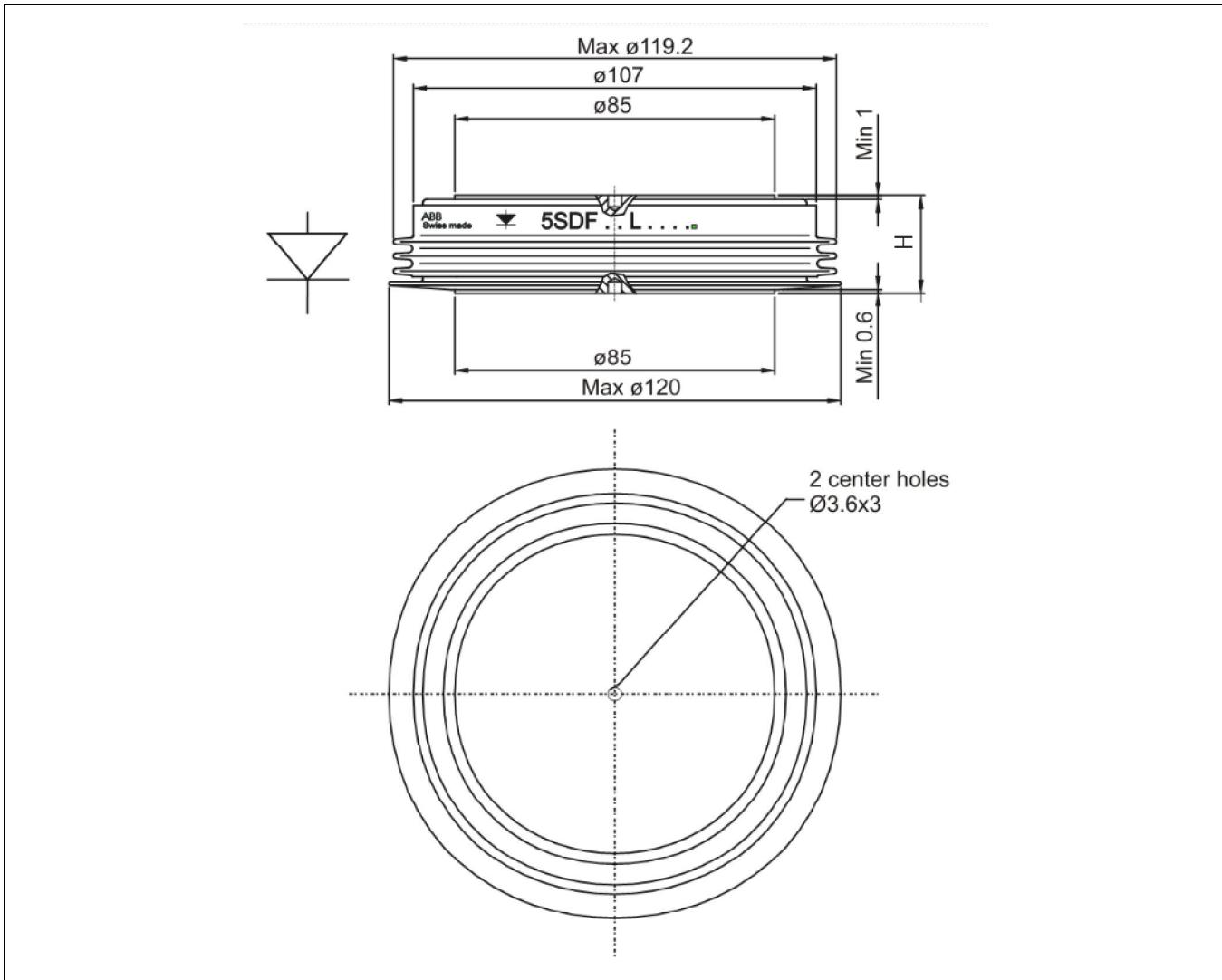


Fig. 8 Device Outline Drawing

Related documents:

Doc. Nr.	Title
5SYA 2036	Recommendations regarding mechanical clamping of Press Pack High Power Semiconductors
5SYA 2064	Applying Fast Recovery Diodes
5SZK 9104	Specification of environmental class for pressure contact diodes, PCTs and GTO, STORAGE
5SZK 9105	Specification of environmental class for pressure contact diodes, PCTs and GTO, TRANSPORTATION
5SZK 9115	Specification of environmental class for presspack Diodes, PCTs and GTOs, OPERATION (Industry)
5SZK 9116	Specification of environmental class for presspack Diodes, PCTs and GTOs, OPERATION (Traction)

Please refer to <http://www.abb.com/semiconductors> for current version of documents.

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Doc. No. 5SYA1186-03 Jun. 19

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